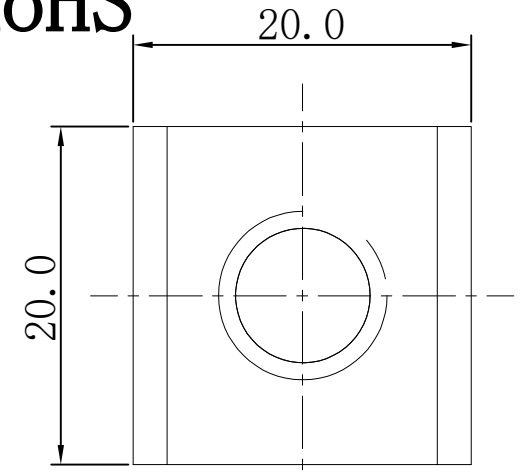
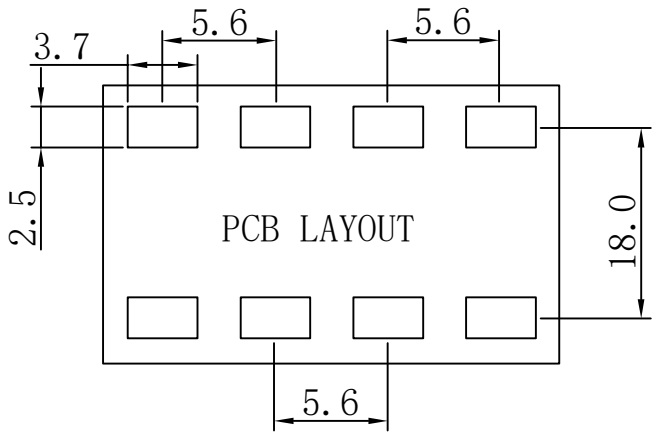
RoHS

| REV. | ECN NO. | DESCRIPTION | DESIGN | APPROVAL | DATE |
|---|---|---|---|---|---|
| A1 | NEW | 新版发行 | | | 2025.09.20 |




技术要求：

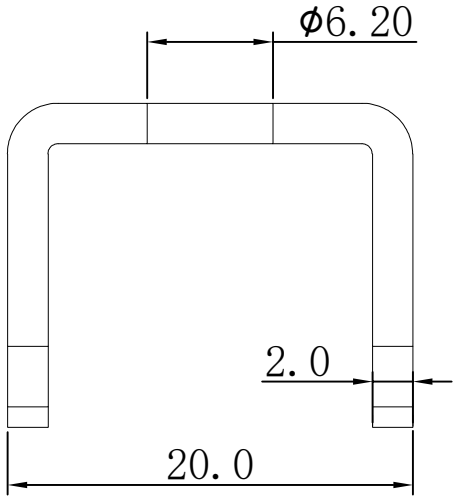
1.打铜底0.5-1μm,镍2-2.5μm，镀亮锡3-5μm。

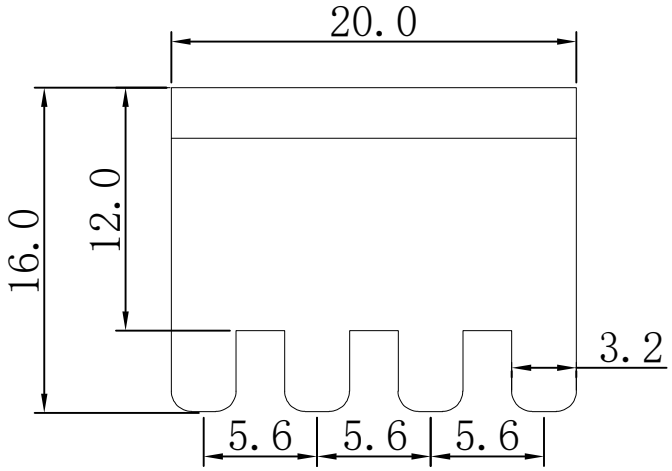
2.铆好后不得有松动现象。

3.插脚尖部符合可焊性要求。

4.螺纹需符合通止规/止针要求。

5.额定电流 ： 180A.




| | | | | |
|---|---|---|---|---|
| 1 | 插脚 | | T2(Y2) | 1 |
| 序号 | 名称 | 零件编号 | 材质 | 数量 |

| | |
|---|---|
| ＞30.±0.4 | X.°± |
| 6-30±0.3 | .X°± |
| 0-6±0.2 | .XX°± |
| ANGLES±1° | .XXX°± |
| UNITS: | mm |

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PART NO: T68200200-1600

TITLE: PCB SOLDERING TERMINAL

| | |
|---|---|
| APPD | Chen ZhiQiang |
| CHKD | Liu Wei |
| DRAW | Chen HongJiang |
| DATE | 2025.09.20 |

**XFCN** 兴飞连接器
0769-82001899
www.xfconn.com

DWG NO: /

| VIEW | | |
|---|---|---|
| SCALE | SHEET | REV |
| NONE | 1/1 | A1 |